

General Purpose Transistor Array One Differentially Connected Pair and Three Isolated Transistor Arrays

The MC3346 is designed for general purpose, low power applications for consumer and industrial designs.

- Guaranteed Base-Emitter Voltage Matching
- Operating Current Range Specified: 10 μA to 10 mA
- Five General Purpose Transistors in One Package

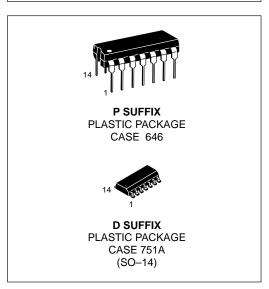
MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------|-------------|------------|
| Collector–Emitter Voltage | VCEO | 15 | Vdc |
| Collector-Base Voltage | Vсво | 20 | Vdc |
| Emitter-Base Voltage | V _{EB} | 5.0 | Vdc |
| Collector–Substrate Voltage | VCIO | 20 | Vdc |
| Collector Current – Continuous | IC | 50 | mAdc |
| Total Power Dissipation @ T _A = 25°C Derate above 25°C | PD | 1.2 10 | W mW/°C |
| Operating Temperature Range | TA | -40 to +85 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |

MC3346

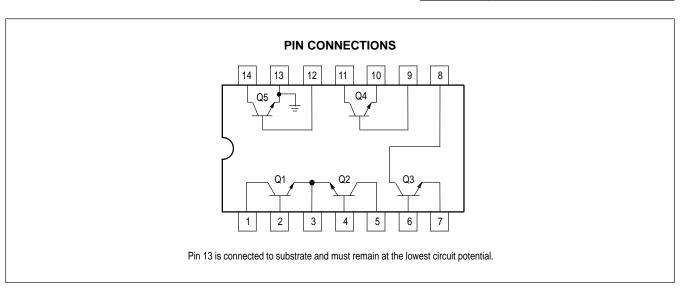
GENERAL PURPOSE TRANSISTOR ARRAY

SEMICONDUCTOR TECHNICAL DATA



ORDERING INFORMATION

| Device | Operating Temperature Range | Package |
|---------|--|-------------|
| MC3346D | $T_{\Delta} = -40^{\circ} \text{ to } +85^{\circ}\text{C}$ | SO-14 |
| MC3356P | 1A = -40 10 +65 C | Plastic DIP |



MC3346

ELECTRICAL CHARACTERISTICS (T_A = +25°C, unless otherwise noted.)

| Characteristics | Symbol | Min | Тур | Max | Unit |
|--|--|--------------|------------------|-------------|-------------------|
| STATIC CHARACTERISTICS | | | | | _ |
| Collector–Base Breakdown Voltage ($I_C = 10 \mu Adc$) | V(BR)CBO | 20 | 60 | _ | Vdc |
| Collector–Emitter Breakdown Voltage (I _C = 1.0 mAdc) | V(BR)CEO | 15 | - | - | Vdc |
| Collector–Substrate Breakdown Voltage (I _C = 10 μA) | V(BR)CIO | 20 | 60 | - | Vdc |
| Emitter–Base Breakdown Voltage (I _E = 10 μAdc) | V(BR)EBO | 5.0 | 7.0 | - | Vdc |
| Collector–Base Cutoff Current (V _{CB} = 10 Vdc, I _E = 0) | ICBO | - | _ | 40 | nAdc |
| DC Current Gain (I _C = 10 mAdc, V_{CE} = 3.0 Vdc) (I _C = 1.0 mAdc, V_{CE} = 3.0 Vdc) (I _C = 10 μ Adc, V_{CE} = 3.0 Vdc) | hFE | - 40 - | 140 130 60 | - - - | - |
| Base–Emitter Voltage (V _{CE} = 3.0 Vdc, I _E = 1.0 mAdc) (V _{CE} = 3.0 Vdc, I _E = 10 mAdc) | VBE | _ _ | 0.72 0.8 | - - | Vdc |
| Input Offset Current for Matched Pair Q1 and Q2 (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc) | 101 - 102 | - | 0.3 | 2.0 | μAdc |
| Magnitude of Input Offset Voltage (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc) | - | - | 0.5 | 5.0 | mVdc |
| Temperature Coefficient of Base–Emitter Voltage (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc) | $\frac{\Delta V_{BE}}{D_{T}}$ | - | -1.9 | _ | mV/°C |
| Temperature Coefficient | <u> ΔV_{IO} </u> D _T | - | 1.0 | _ | μV/°C |
| Collector–Emitter Cutoff Current (VCE = 10 Vdc, IB = 0) | ICEO | - | _ | 0.5 | μAdc |
| DYNAMIC CHARACTERISTICS | | | | | |
| Low Frequency Noise Figure (V _{CE} = 3.0 Vdc, I _C = 100 μ Adc, R _S = 1.0 k Ω , f = 1.0 kHz) | NF | _ | 3.25 | - | dB |
| Forward Current Transfer Ratio (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 kHz) | hFE | - | 110 | - | - |
| Short Circuit Input Impedance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc) | h _{ie} | - | 3.5 | - | kΩ |
| Open Circuit Output Impedance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc) | h _{oe} | - | 15.6 | - | μmhos |
| Reverse Voltage Transfer Ratio (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc) | h _{re} | - | 1.8 | - | x10 ⁻⁴ |
| Forward Transfer Admittance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 MHz) | Уfе | - | 31–j1.5 | - | - |
| Input Admittance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 MHz) | Уіе | - | 0.3 + j0.04 | - | - |
| Output Admittance (V _{CE} = 3.0 Vdc, I _C = 1.0 mAdc, f = 1.0 MHz) | Уое | - | 0.001 + j0.03 | - | - |
| Current–Gain – Bandwidth Product (V _{CE} = 3.0 Vdc, I _C = 3.0 mAdc) | fT | 300 | 550 | - | MHz |
| Emitter-Base Capacitance (VEB = 3.0 Vdc, IE = 0) | C _{eb} | - | 0.6 | - | pF |
| Collector–Base Capacitance (V _{CB} = 3.0 Vdc, I _C = 0) | C _{cb} | - | 0.58 | - | pF |
| Collector–Substrate Capacitance (V _{CS} = 3.0 Vdc, I _C = 0) | CCI | _ | 2.8 | - | pF |

Figure 1. Collector Cutoff Current versus Temperature (Each Transistor)

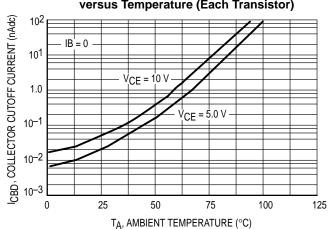


Figure 2. Collector Cutoff Current versus Temperature (Each Transistor)

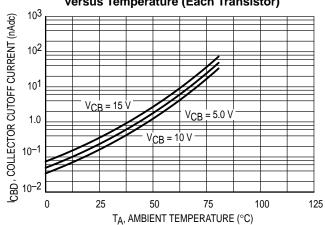


Figure 3. Input Offset Characteristics for Q1 and Q2

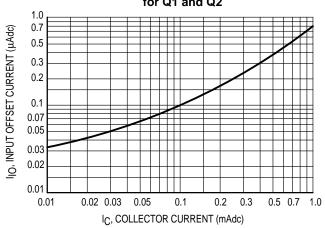


Figure 4. Base–Emitter and Input Offset Voltage Characteristics

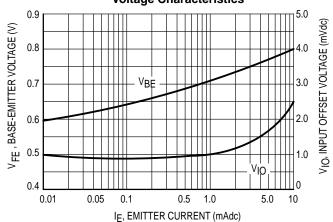
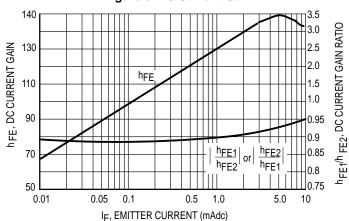
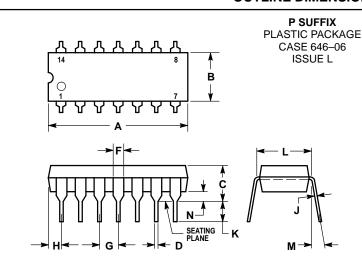


Figure 5. DC Current Gain



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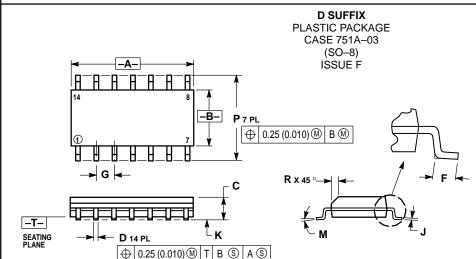
OUTLINE DIMENSIONS



NOTES

- LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- 4. ROUNDED CORNERS OPTIONAL.

| | INCHES | | MILLIMETERS | | |
|-----|-----------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.715 | 0.770 | 18.16 | 19.56 | |
| В | 0.240 | 0.260 | 6.10 | 6.60 | |
| С | 0.145 | 0.185 | 3.69 | 4.69 | |
| D | 0.015 | 0.021 | 0.38 | 0.53 | |
| F | 0.040 | 0.070 | 1.02 | 1.78 | |
| G | 0.100 BSC | | 2.54 BSC | | |
| Н | 0.052 | 0.095 | 1.32 | 2.41 | |
| J | 0.008 | 0.015 | 0.20 | 0.38 | |
| K | 0.115 | 0.135 | 2.92 | 3.43 | |
| L | 0.300 BSC | | 7.62 BSC | | |
| М | 0° | 10° | 0° | 10° | |
| N | 0.015 | 0.039 | 0.39 | 1.01 | |



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 8.55 | 8.75 | 0.337 | 0.344 |
| В | 3.80 | 4.00 | 0.150 | 0.157 |
| С | 1.35 | 1.75 | 0.054 | 0.068 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.40 | 1.25 | 0.016 | 0.049 |
| G | 1.27 BSC | | 0.050 BSC | |
| J | 0.19 | 0.25 | 0.008 | 0.009 |
| K | 0.10 | 0.25 | 0.004 | 0.009 |
| M | 0 ° | 7° | 0 ° | 7° |
| Р | 5.80 | 6.20 | 0.228 | 0.244 |
| R | 0.25 | 0.50 | 0.010 | 0.019 |

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